OR 2005/08/08 13:06	OR 2005/03/23 15:23	OR 0N 2005/08/08 13:16	OR 2005/03/23 15:27	OR 2005/08/08 11:21	OR	OR 2005/08/08 11:21	OR 2005/08/08 11:22
US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	USPAT; USPAT; EPO; IPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM TDB
(nano\$1probe (nano adj probe)) same (substrate material \$5film coat\$3 layer sheet pad wafer film lamina level plane)	6 S72 and @ad<"20030922"	S73 and ((project\$5 protrud\$5 extend\$5) near2 (portion part member moiety parcel piece section segment))	3 S74 and (conduct\$5 near2 (wir\$3 cord\$3 cabl\$3 line link channel connect\$5 lead\$3))	1 (324/724.ccls.) and @ad<"20030922" and @pd>"20050316"	4 (324/722,691.ccls.) and @ad<"20030922" and @pd>"20050316"	4 (324/649,600.ccls.) and @ad<"20030922" and @pd>"20050316"	82 (324/751,752,754,755,757,758.ccls.) and @ad<"20030922" and @pd>"20050316"
76	99	•			-		∞
S72	S73	S74	S75	S76	S77	S78	S79

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2005/08/08 11:22	2005/08/08 11:22	2005/08/08 11:53	2005/08/08 13:39	2005/08/08 13:39	2005/08/08 14:42	2005/08/08 13:40	2005/08/08 14:25
Z	N O	N O	Z O	NO	N O	NO	NO
OR	OR	OR	OR	OR	OR	OR	OR
US-PGPUB; USPAT; EPO; IPO; DERWENT ; IBM_TDB	USPAT; USPAT; EPO; IPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	USPAT; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; IPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB
162 (324/72.5,715,765,158.1.ccls.) and @ad<"20030922" and @pd>"20050316"	3 (324/437,445-447.ccls.) and @ad<"20030922" and @pd>"20050316"	1 (324/690,696.ccls.) and @ad<"20030922" and @pd>"20050316"	(nano\$1probe (nano adj probe)) same (substrate material \$5film coat\$3 layer sheet pad wafer film lamina level plane) and @ad<"20030922"	S83 and ((project\$5 protrud\$5 extend\$5) near2 (portion part member moiety parcel piece section segment compartment component assembly unit tool))	(nano\$1probe (nano adj probe)) and @ad<"20030922"	S85 and ((project\$5 protrud\$5 extend\$5) near2 (portion part member moiety parcel piece section segment compartment component assembly unit tool))	1462 (600/11,459,462.ccls.) and @ad<"20030922"
280	S81	S82	S83	S84	S85	286	888

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2005/08/10 09:16	2005/08/08 14:35	2005/08/08 14:42	2005/08/08 15:02	2005/08/08 15:07	2005/08/10 09:25	2005/08/10 09:17
NO	OFF	NO	NO .	N O	N O	NO
OR	OR	OR	OR	OR	OR	OR
US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	USPAT; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB
(600/372,373,393.ccls.) and @ad<"20030922"	("20050062488").PN.	S88 and (nano\$1probe (nano adj probe))	S89 and (nano\$1probe (nano adj probe))	(((nano\$1probe (nano adj probe)) and (project\$5 protrud\$5 extend\$5) and (substrate material \$5film coat\$3 layer sheet pad wafer film lamina level plane) and (portion part member moiety parcel piece section segment compartment component assembly unit tool) and (plural\$5 number multipl\$5 series several set) and conduct\$5).clm.) and @ad<"20030922"	(((nano\$1probe (nano adj probe)) and (project\$5 protrud\$5 extend\$5) and (substrate material \$5film coat\$3 layer sheet pad wafer film lamina level plane) and (portion part member moiety parcel piece section segment compartment component assembly unit tool) and (plural\$5 number multipl\$5 series several set) and conduct\$5 and (flexible conformable adaptable adjustable bendable tractable moldable stretchable elastic extensible) and (stiff\$4 rigid\$5 \$2flexib\$5).clm.) and @ad<"20030922"	\$5probe and @ad<"20030922"
807	2	0	0		0	297721
888	06S	S91	S92		S94	S9S

968	3762	S95 and ((project\$5 protrud\$5 extend\$5) near2 (portion part member moiety parcel piece section segment)) same (stiff\$4 rigid\$5 \$2ffexib\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	NO O	2005/08/10 09:20
297	798	S95 and ((project\$5 protrud\$5 extend\$5) near2 (portion part member moiety parcel piece section segment)) near3 (stiff\$4 rigid\$5 \$2flexib\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	NO O	2005/08/10 09:22
868	496	S97 and (electrode plate contact pole tip probe) with (flexib\$5 conformable adaptable adjustable bendable tractable moldable stretchable elastic extensible)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	NO O	2005/08/10 09:23
899	345	S97 and (electrode plate contact pole tip probe) near3 (flexib\$5 conformable adaptable adjustable bendable tractable moldable stretchable elastic extensible)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	0	2005/08/10 09:23
S100	61	S99 and (plural\$5 number multipl\$5 series several set) near3 conduct\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	N O	2005/08/10 09:26
S101	2	("6788086").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/08/17 13:33